

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
QI DING TECHNOLOGY QINHUANGDAO CO., LTD.	08/01/2023
ZHEN DING TECHNOLOGY CO., LTD.	08/01/2023
RECEIVING PARTY DATA	
Name:	LEADING INTERCONNECT SEMICONDUCTOR TECHNOLOGY QINHUANGDAO CO., LTD.
Street Address:	NO.18-2 TENGFEI ROAD,ECONOMY AND TECHNOLOGY DEVELOPMENT ZONE
City:	QINHUANGDAO CITY
State/Country:	CHINA
Name:	ZHEN DING TECHNOLOGY CO., LTD.
Street Address:	NO. 6, LANE 28, SAN HO RD., SAN SHI VILLAGE
City:	TAYUAN, TAOYUAN
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 29	
Property Type	Number
Patent Number:	9905508
Patent Number:	9362248
Patent Number:	9357647
Patent Number:	9173298
Patent Number:	9107332
Patent Number:	9089082
Patent Number:	9024203
Patent Number:	9730328
Patent Number:	9271388
Patent Number:	9099450
Patent Number:	9015936
Patent Number:	9548427
Patent Number:	9472426
Patent Number:	9439282
Patent Number:	9295150

Property Type	Number
Patent Number:	8941227
Patent Number:	8853000
Patent Number:	10412835
Patent Number:	9992873
Patent Number:	9855629
Patent Number:	9786589
Patent Number:	9439281
Patent Number:	9332656
Patent Number:	9265146
Patent Number:	9190386
Patent Number:	9165790
Patent Number:	9159614
Patent Number:	9000573
Patent Number:	8951848

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	CALVIN H CHAI
SIGNATURE:	/Calvin H Chai/
DATE SIGNED:	09/14/2023

Total Attachments: 4

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ASSIGNMENT OF U.S. PATENTS

WHEREAS, **Qi Ding Technology Qinhuangdao Co., Ltd.** having a principal place of business at **No.18, TengFei Road, Economic and Technological Development Zone, Qinhuangdao, Hebei Province, China** and **Zhen Ding Technology Co., Ltd.** having a principal place of business at **No. 6, Lane 28, San Ho Rd., San Shi Village, Tayuan, Taoyuan, Taiwan, R.O.C.** are the owners of the U.S. patents listed below by virtue of assignments recorded in the United States Patent and Trademark Office, also as listed below.

Application No	Application Date	Issue No	Issue Date
15/693198	2017/08/31	9905508	2018/02/27
14/331330	2014/07/15	9362248	2016/06/07
13/971854	2013/08/21	9357647	2016/05/31
14/097251	2013/12/05	9173298	2015/10/27
13/864232	2013/04/16	9107332	2015/08/11
14/109913	2013/12/17	9089082	2015/07/21
13/928701	2013/06/27	9024203	2015/05/05
14/138126	2013/12/23	9730328	2017/08/08
14/064202	2013/10/28	9271388	2016/02/23
14/084627	2013/11/20	9099450	2015/08/04
13/891204	2013/05/10	9015936	2015/04/28
14/864585	2015/09/24	9548427	2017/01/17
14/841721	2015/09/01	9472426	2016/10/18

13/949237	2013/07/24	9439282	2016/09/06
14/035957	2013/09/25	9295150	2016/03/22
14/101352	2013/12/10	8941227	2015/01/27
13/777043	2013/02/26	8853000	2014/10/07
15/953560	2018/04/16	10412835	2019/09/10
14/967907	2015/12/14	9992873	2018/06/05
14/834673	2015/08/25	9855629	2018/01/02
14/857020	2015/09/17	9786589	2017/10/10
13/947114	2013/07/22	9439281	2016/09/06
14/150723	2014/01/08	9332656	2016/05/03
13/925136	2013/06/24	9265146	2016/02/16
14/139790	2013/12/23	9190386	2015/11/17
13/968409	2013/08/15	9165790	2015/10/20
14/140461	2013/12/24	9159614	2015/10/13
14/477888	2014/09/05	9000573	2015/04/07
13/771320	2013/02/20	8951848	2015/02/10

Leading Interconnect Semiconductor Technology Qinhuangdao Co., Ltd. having a principal place of business at **No.18-2 Tengfei Road, Economy and Technology Development Zone, Qinhuangdao City, China** and **Zhen Ding Technology Co., Ltd.** having a principal place of business at **No. 6, Lane 28, San Ho Rd., San Shi Village, Tayuan, Taoyuan, Taiwan, R.O.C.** are desirous of acquiring the above identified U.S. patent to be obtained therefrom.

THEREFORE, in consideration of One Dollar (\$1.00) and other goods and valuable considerations, the receipt of which is hereby acknowledged, **Qi Ding Technology Qinhuangdao Co., Ltd.** and **Zhen Ding Technology Co., Ltd.** hereby sell, assign and transfer to **Leading Interconnect Semiconductor Technology Qinhuangdao Co., Ltd.** and **Zhen Ding Technology Co., Ltd.**, its successors and assigns, the entire right, title and interest in the patents listed above and any divisions or continuations thereof, and any reissues or extensions of the listed and any of such U.S. patents. The Commissioner of the U.S. Patent and Trademark Office is hereby authorized and requested to issue such U.S. patents to **Leading Interconnect Semiconductor Technology Qinhuangdao Co., Ltd.** and **Zhen Ding Technology Co., Ltd.**

Qi Ding Technology Qinhuangdao Co., Ltd. and **Zhen Ding Technology Co., Ltd.** hereby covenant that they have full right to convey the entire right, title and interest in the U.S. patents listed above, and have not executed and will not execute any agreement in conflict herewith.

Qi Ding Technology Qinhuangdao Co., Ltd. and **Zhen Ding Technology Co., Ltd.** further covenant that they will, at any time, upon request, execute and deliver any and all papers that may be necessary or desirable to perfect the title in U.S. patents listed above, and if **Leading Interconnect Semiconductor Technology Qinhuangdao Co., Ltd.** and **Zhen Ding Technology Co., Ltd.** or its assignee, desires to secure a reissue or extension of a U.S. patent, or to file a disclaimer relating thereto, that they will upon request, sign all papers, make all rightful oaths and declarations, and do all lawful acts requisite for the such purposes.

Executed and delivered this 1st day of August, 2023

Qi Ding Technology Qinhuangdao Co., Ltd.

By: Lee Ting-chuan

Name: LEE, TING-CHUAN

Title: Executive President

Zhen Ding Technology Co., Ltd.

By: Shen Chang-Fang

Name: SHEN, CHANG-FANG

Title: Chairman